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Jameco Part Number 2001533



# STPS80H100CY

## HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

PRELIMINARY DATASHEET

### MAIN PRODUCT CHARACTERISTICS

<b>I<sub>F(AV)</sub></b>	<b>2 x 40 A</b>
<b>V<sub>RRM</sub></b>	<b>100 V</b>
<b>T<sub>j (max)</sub></b>	<b>175 °C</b>
<b>V<sub>F (max)</sub></b>	<b>0.70 V</b>

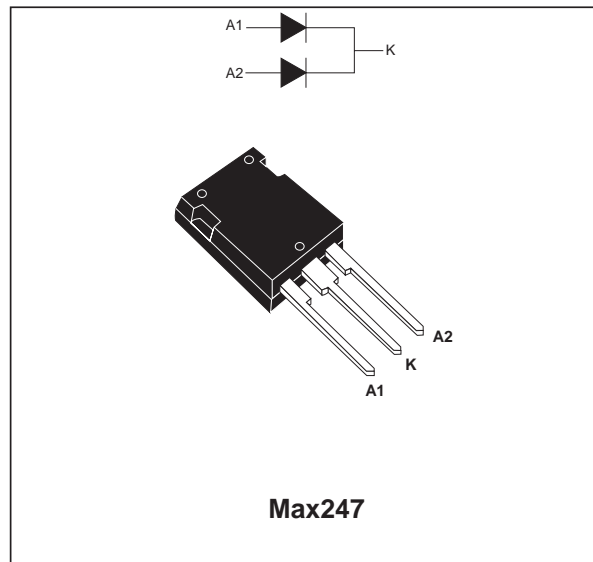
### FEATURES AND BENEFITS

- HIGH REVERSE VOLTAGE
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- LOW LEAKAGE CURRENT
- HIGH TEMPERATURE
- LOW THERMAL RESISTANCE
- AVALANCHE CAPABILITY SPECIFIED

### DESCRIPTION

Dual center tap Schottky rectifier suited for Switched Mode Power Supplies and high frequency DC to DC converters.

Packaged in Max247, this device is intended for use in high frequency computer and telecom converters.



### ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	100	V
I <sub>F(RMS)</sub>	RMS forward current	50	A
I <sub>F(AV)</sub>	Average forward current	T <sub>c</sub> = 155°C δ = 0.5 Per diode: 40 Per device: 80	A
I <sub>FSM</sub>	Surge non repetitive forward current	tp = 10 ms sinusoidal	400 A
I <sub>RRM</sub>	Repetitive peak reverse current	tp = 2 μs square F = 1kHz	2 A
P <sub>ARM</sub>	Repetitive peak avalanche power	tp = 1 μs T <sub>j</sub> = 25°C	39200 W
T <sub>stg</sub>	Storage temperature range	- 65 to + 175	°C
T <sub>j</sub>	Maximum operating junction temperature *	175	°C
dV/dt	Critical rate of rise of reverse voltage	10000	V/μs

\* :  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  thermal runaway condition for a diode on its own heatsink

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## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	Per diode	0.7
		Total	0.5
R <sub>th(c)</sub>	Coupling	0.3	°C/W

When the diodes 1 and 2 are used simultaneously :  
 $\Delta T_j(\text{diode } 1) = P(\text{diode } 1) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode } 2) \times R_{th(c)}$

## STATIC ELECTRICAL CHARACTERISTICS (per diode)

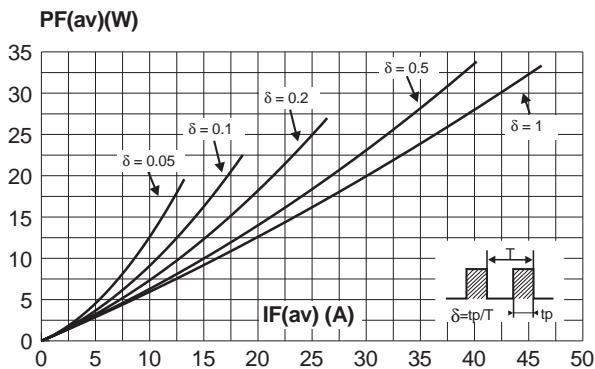
Symbol	Parameter	Tests conditions	Min.	Typ.	Max.	Unit
I <sub>R</sub> *	Reverse leakage current	T <sub>j</sub> = 25°C	V <sub>R</sub> = V <sub>RRM</sub>		20	µA
		T <sub>j</sub> = 125°C		7	20	mA
V <sub>F</sub> **	Forward voltage drop	T <sub>j</sub> = 25°C	I <sub>F</sub> = 40 A		0.8	V
		T <sub>j</sub> = 125°C	I <sub>F</sub> = 40 A	0.65	0.7	
		T <sub>j</sub> = 25°C	I <sub>F</sub> = 80 A		0.94	
		T <sub>j</sub> = 125°C	I <sub>F</sub> = 80 A	0.79	0.84	

Pulse test : \* t<sub>p</sub> = 5 ms, δ < 2 %  
 \*\* t<sub>p</sub> = 380 µs, δ < 2%

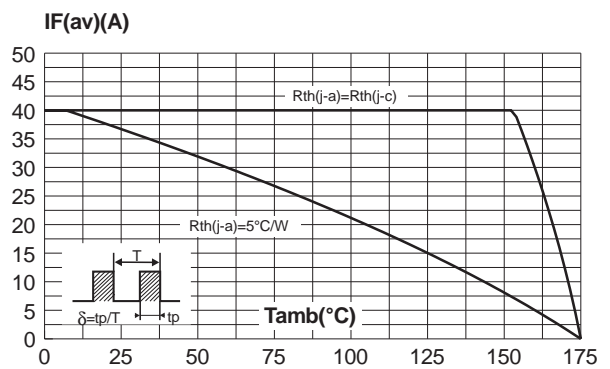
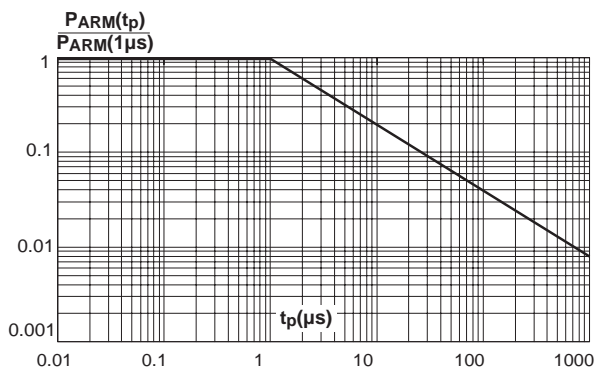
To evaluate the maximum conduction losses use the following equation :  
 $P = 0.56 \times I_{F(AV)} + 0.0035 \times I_{F(RMS)}^2$

**Fig. 1:** Average forward power dissipation versus average forward current (per diode).

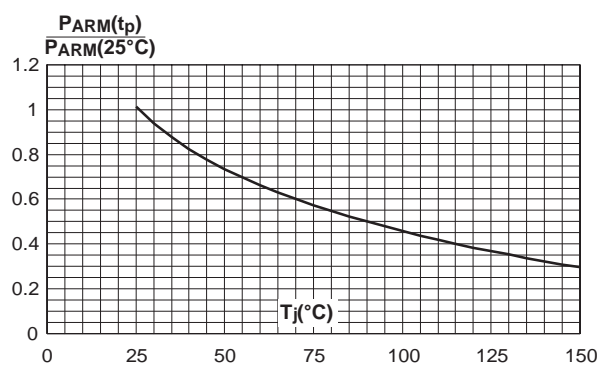
**Fig. 2:** Average forward current versus ambient temperature (δ=0.5, per diode).



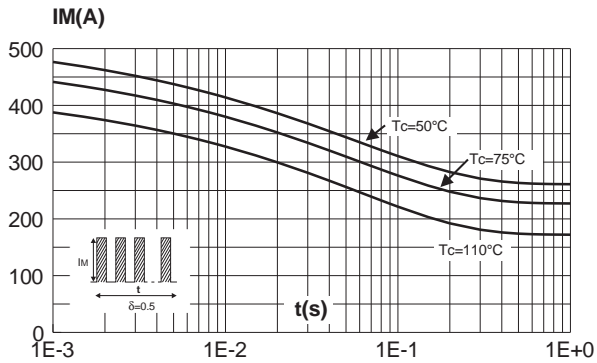
**Fig. 3:** Normalized avalanche power derating versus pulse duration.



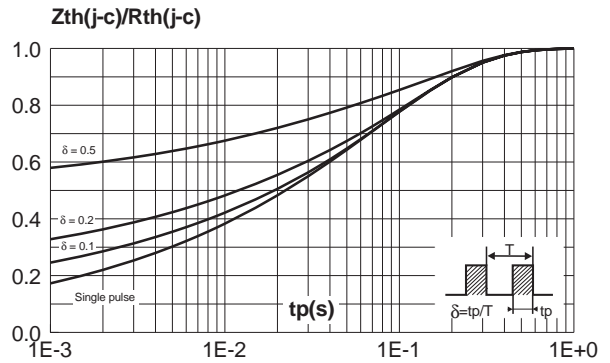
**Fig. 4:** Normalized avalanche power derating versus junction temperature.



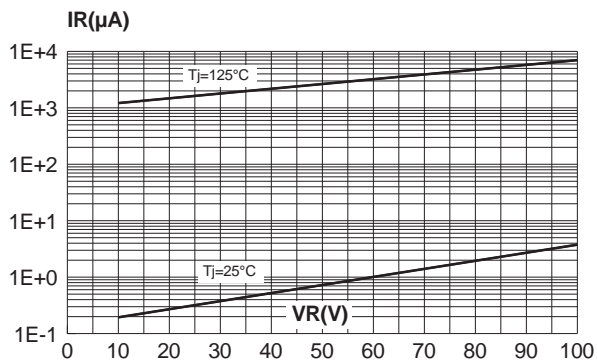
**Fig. 5:** Non repetitive surge peak forward current versus overload duration (maximum values, per diode).



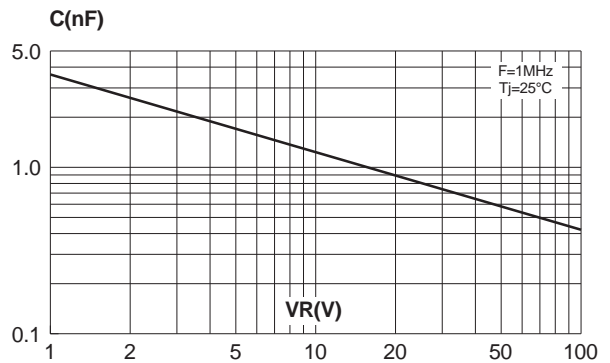
**Fig. 6:** Relative variation of thermal impedance junction to case versus pulse (per diode).



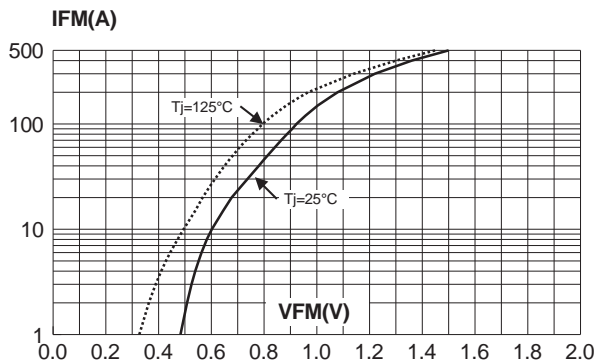
**Fig. 7:** Reverse leakage current versus reverse voltage applied (typical values, per diode).



**Fig. 8:** Junction capacitance versus reverse voltage applied (typical values, per diode).



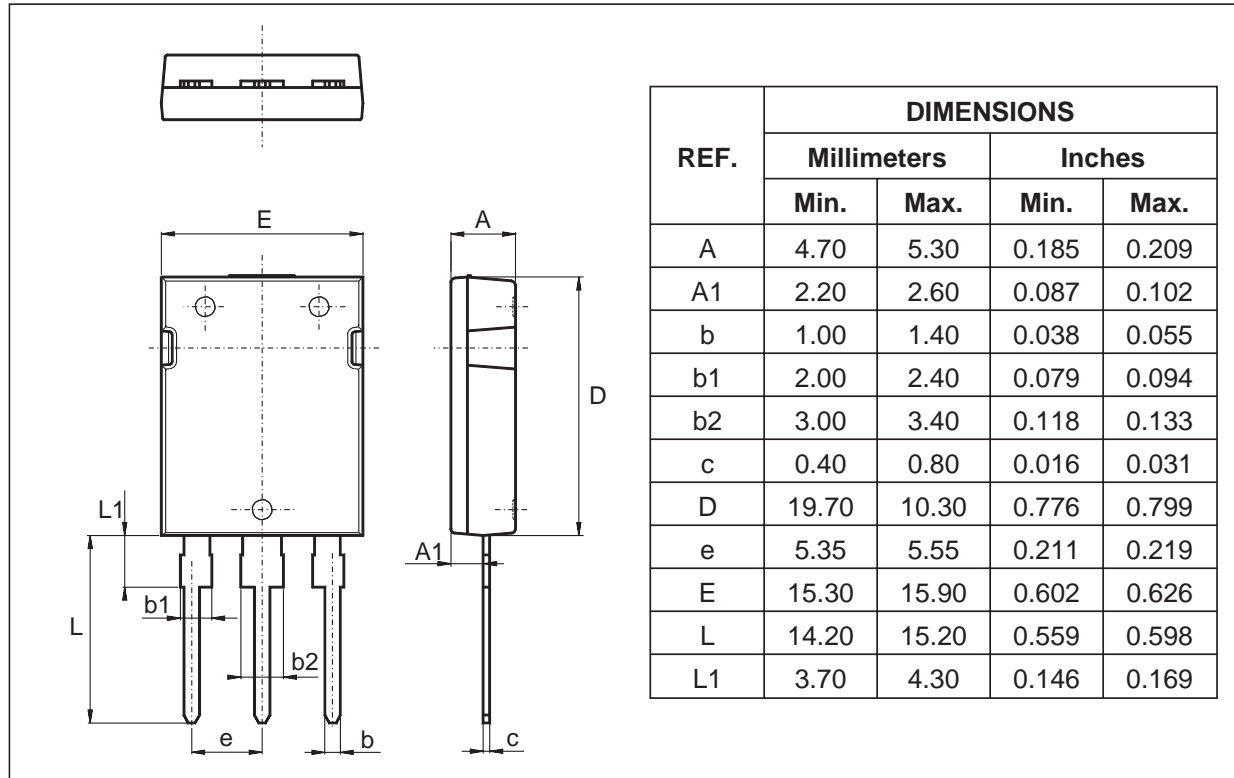
**Fig. 9:** Forward voltage drop versus forward current (maximum values, per diode).



# STPS80H100CY

## PACKAGE MECHANICAL DATA

Max247



Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS80H100CY	STPS80H100CY	Max247	4.4g	30	Tube

- EPOXY MEETS UL94,V0

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